



# **Description**

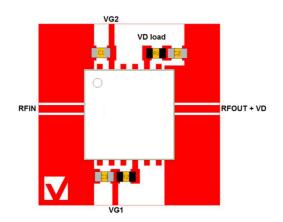
The CBMDC281721VP is a distributed amplifier designed on a 0.15 µm pHEMT process, packaged in a 5x5mm 24 lead Plastic Surface Mount Package (ROHS).

The device is capable of more than +21dBm of output power at saturation regime, up to 28GHz. And more than +19 dBm of output power at 1 dB of gain compression, up to 20GHz. It provides 15 dB of linear gain from DC to 28 GHz. The Design has been optimized to provide high efficiency. The supply current is as low as 200 mA when operating with VD=+9V.

#### **Applications**

- Wide band MPA
- Radar / ECM / ECCM
- Test and measurement
- Broadband / datalink communication

#### **Suggested Board Layout and** recommended decoupling components



C1, C2, C3: 0402 1µF/16V capacitor

R1, R2 :  $10 \Omega$  resistor

#### **CBMDC281721VP**

DC to 28 GHz - 15 dB - 20 dBm **Medium Power QFN MMIC** 

#### **Features**

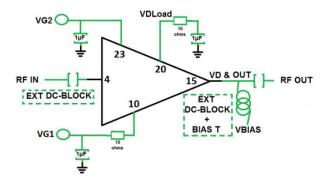
- Distributed amplifier pHEMT GaAs MMIC
- Wide band: DC to 28 GHz.
- Flat group delay
- $50\Omega RF$  Single ended input and output
- DC coupled IN, DC coupled Out
- P1dB >+19dBm DC to 20GHz
- High output Psat >+21dBm DC to 28GHz
- Small signal gain: 15dB from DC to 28GHz
- Power supply: 200 mA @ +9V
- Package: QFN 5x5mm 24 Lead

#### **Tools**

S2P file can be provided for system design simulation. DXF drawing file is available for mechanical design. Evaluation board available on request.

### **Ordering information**

Product code	Definition	
CBMDC281721VP	QFN 5x5mm 24Lead MPA	



 $1\mu F$  / 100 hms : 0402 capacitor / resistor, must be placed as close as possible to the QFN access

## **Typical Characteristics**

Tamb =  $25^{\circ}$ C, VD = +9V, VG2=+2V, ID = 200 mA.

Parameter measured	Symbol	Min	Тур	Max	Unit
Frequency range	F	DC		28	GHz
Small signal gain	G		15		dB
Small signal gain flatness	ΔG		+/-1		dB
Input return loss	S11	-5	-8		dB
Output return loss	S22		-10		dB
Output P1 dB from DC to 20GHz	P1dB		20		dBm
Saturated output power	PSat		22		dBm
Drain supply voltage	VD		9		V
Supply current	ID		200		mA

## **Environmental parameters**

<b>Environment Parameters</b>	Symbols	Min	Max	Units
Storage temperature	Tst	-55	+85	°C
Operating temperature	Тор	-40	+85	°C

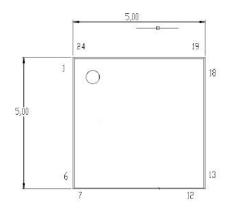
## **Absolute maximum ratings**

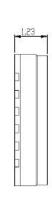
Maximum ratings	Symbols	Min	Max	Units
Positive external DC bias voltage	VD		10	V
RF input power (In)	Pin max		20	dBm
Continuous power dissipation (@ 85°C)	Pcw		2	W

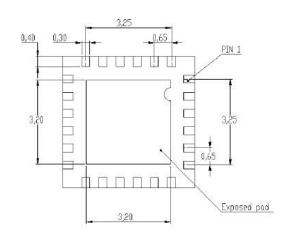


# PRELIMINARY DATA SHEET

## **Mechanical Drawing**





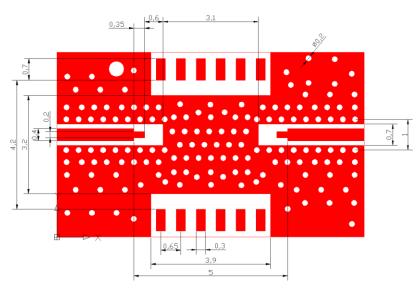


> QFN exposed PAD must be connected to ground (RF and DC).

# **Recommended Layout**

Substrate : Rogers RO4350

Thickness: 0.254 mm



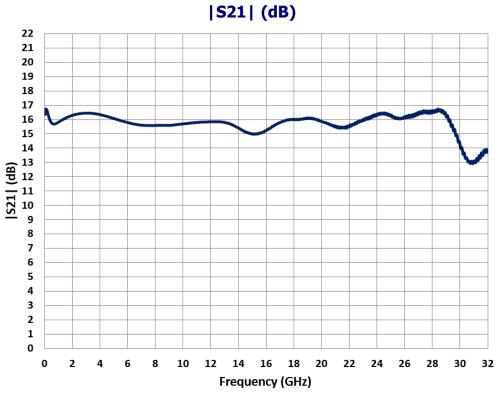
## **Access description**

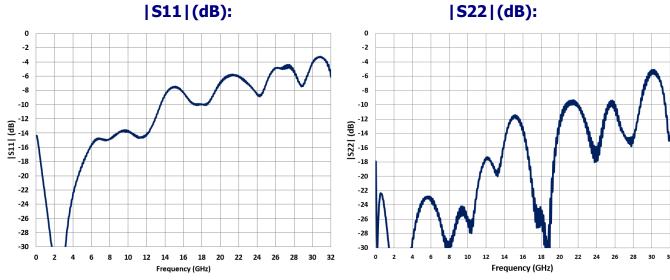
Pin number	Name	Description	Electrical interface
4	HF_AMP_INPUT	HF Amplifier input, This access is DC coupled and internally matched to 500hms.	
23	VG2	Gate control input access for second stage distributed amplifier structure. Apply +2V for nominal biasing conditions.	VG 2 VD & RF OUT (15)
10	VG1	Gate control input access for first stage distributed amplifier structure. Apply 0V for nominal biasing conditions.	(23)
20	VDLoad	Drain termination load decoupling access.	VG1 (4)
15	HF_AMP_OUTPUT	HF Amplifier output, This access is DC coupled and internally matched to 500hms. It is also used to feed the drain current (ID), by using a wide bandwidth external Bias-T structure.	T GND
Exposed PAD	GND	Ground paddle must be connected to HF and DC Ground	<b>₽</b> GND
3, 5, 14, 16	GND	This PINS must be connected to HF and DC Ground	$ar{ar{\delta}}$ and

### **Typical performances characteristics**

Biasing conditions: VD=+9V, VG2=+2V, ID=200mA, T=25°C.

Measurements including QFN connections access on PCB.





#### **Handling**

This product is sensitive to electrostatic discharge and should not be handled except at a static free workstation. Take precautions to prevent ESD; use wrist straps, grounded work surfaces and recognized anti-static techniques when handling the CBMDC281721VP device. ATTENTION